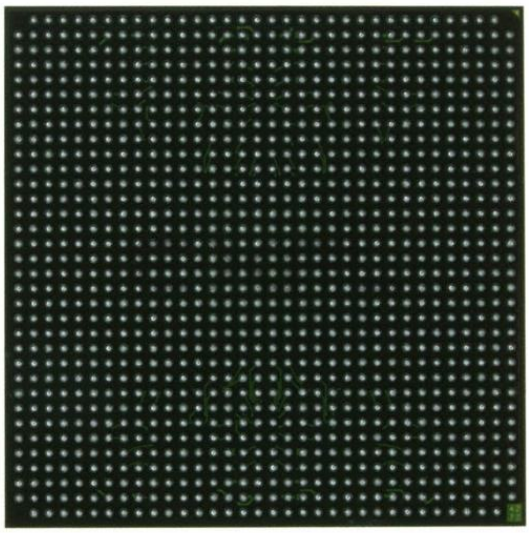

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	4848
Number of Logic Elements/Cells	43632
Total RAM Bits	3538944
Number of I/O	692
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp40-5ff1152i

Disparity Control

The 8B/10B encoder is initialized with a negative running disparity. Unique control allows forcing the current running disparity state.

TXRUNDISP signals its current running disparity. This may be useful in those cases where there is a need to manipulate the initial running disparity value.

Bits TXCHARDISPMODE and TXCHARDISPVAL control the generation of running disparity before each byte.

For example, the transceiver can generate the sequence

```
K28.5+ K28.5+ K28.5- K28.5-
```

or

```
K28.5- K28.5- K28.5+ K28.5+
```

by specifying inverted running disparity for the second and fourth bytes.

Transmit FIFO

Proper operation of the circuit is only possible if the FPGA clock (TXUSRCLK) is frequency-locked to the reference clock (REFCLK). Phase variations up to one clock cycle are allowable. The FIFO has a depth of four. Overflow or underflow conditions are detected and signaled at the interface. Bypassing of this FIFO is programmable.

8B/10B Encoder

Note: In the RocketIO transceiver, the most-significant byte is sent first; in the RocketIO X transceiver, the least-significant byte is sent first.

A bypassable 8B/10B encoder is included. The encoder uses the same 256 data characters and 12 control characters used by Gigabit Ethernet, Fibre Channel, and InfiniBand.

The encoder accepts 8 bits of data along with a K-character signal for a total of 9 bits per character applied, and generates a 10 bit character for transmission. If the K-character signal is High, the data is encoded into one of the twelve possible K-characters available in the 8B/10B code. If the K-character input is Low, the 8 bits are encoded as standard data. If the K-character input is High, and a user applies other than one of the twelve possible combinations, TXKERR indicates the error.

8B/10B Decoder

Note: In the RocketIO transceiver, the most-significant byte is sent first; in the RocketIO X transceiver, the least-significant byte is sent first.

An optional 8B/10B decoder is included. A programmable option allows the decoder to be bypassed. When the 8B/10B decoder is bypassed, the 10-bit character order is, for example,

RXCHARISK[0] (first bit received)
RXRUNDISP[0]
RXDATA[7:0] (last bit received is RXDATA[0])

The decoder uses the same table that is used for Gigabit Ethernet, Fibre Channel, and InfiniBand. In addition to decoding all data and K-characters, the decoder has several extra features. The decoder separately detects both “disparity errors” and “out-of-band” errors. A disparity error is the reception of 10-bit character that exists within the 8B/10B table but has an incorrect disparity. An out-of-band error is the reception of a 10-bit character that does not exist within the 8B/10B table. It is possible to obtain an out-of-band error without having a disparity error. The proper disparity is always computed for both legal and illegal characters. The current running disparity is available at the RXRUNDISP signal.

The 8B/10B decoder performs a unique operation if out-of-band data is detected. If out-of-band data is detected, the decoder signals the error and passes the illegal 10-bits through and places them on the outputs. This can be used for debugging purposes if desired.

The decoder also signals the reception of one of the 12 valid K-characters. In addition, a programmable comma detect is included. The comma detect signal registers a comma on the receipt of any comma+, comma–, or both. Since the comma is defined as a 7-bit character, this includes several out-of-band characters. Another option allows the decoder to detect only the three defined commas (K28.1, K28.5, and K28.7) as comma+, comma–, or both. In total, there are six possible options, three for valid commas and three for "any comma."

Note that all bytes (1, 2, 4, or 8) at the RX FPGA interface each have their own individual 8B/10B indicators (K-character, disparity error, out-of-band error, current running disparity, and comma detect).

Receiver Buffer

The receiver includes buffers (FIFOs) in the datapath. This section gives the reasons for including the buffers and outlines their operation.

The receiver buffer is required for two reasons:

- *Clock correction* to accommodate the slight difference in frequency between the recovered clock RXRECCLK and the internal FPGA user clock RXUSRCLK
- *Channel bonding* to allow realignment of the input stream to ensure proper alignment of data being read through multiple transceivers

The receiver uses an *elastic buffer*, where "elastic" refers to the ability to modify the read pointer for clock correction and channel bonding.

Comma Detection

Word alignment is dependent on the state of comma detect bits. If comma detect is enabled, the transceiver recognizes up to two 10-bit preprogrammed characters. Upon detection of the character or characters, the comma detect output is driven high and the data is synchronously aligned. If a comma is detected and the data is aligned, no further alignment alteration takes place. If a comma is received and realignment is necessary, the data is realigned and an indi-

RocketIO and RocketIO X Feature Comparison

Table 7 summarizes the major differences between the RocketIO and RocketIO X MGTs. The ***RocketIO X Transceiver User Guide*** has more details, including a design migration guide in the Appendix.

Table 7: **RocketIO PMA versus RocketIO X PMA**

	RocketIO X Transceiver	RocketIO Transceiver
PCS Features:		
FPGA interface	1, 2, 4, and 8 byte width	1, 2, and 4 byte width
Coding support	8B/10B and 64B/66B bypassable	8B/10B bypassable
Gearbox/scrambler support	Yes	N/A
CRC Support	No	Yes
Half rate	No	Yes
PMA Features:		
Baud rate	2.488 Gb/s - 6.25 Gb/s(2)	622 Mb/s - 3.125 Gb/s
Reference clock frequency tolerance	350 PPM	100 PPM
Reference clock multiplier	x16, x20, x32, x40	x20
Max run length	75	75
Receive equalization	Built-in analog linear, programmable	None
Output swing (differential p-p)	200 mV to 1600 mV, programmable	800 mV to 1600 mV, programmable
Pre-emphasis	0% to 500%, programmable	4 selectable levels from 10% to 33%
Slew rate control	2 selectable levels	None
Termination	On-chip internal, 50Ω	On-chip internal, 50Ω/75Ω selectable
AC coupling capacitor	On-chip internal. Can be AC- or DC-coupled externally	None
Transmit supply voltage (AVCCAUXTX)	2.5V	2.5V
Receive supply voltage (AVCCAUXRX)	1.5V, 1.8V(1)	2.5V
PMA configuration support	Direct, dynamic, and partial configuration	Partial configuration
Others:		
JTAG support	Input only	None
Process technology	0.13 µm	0.25 µm
Available packages	Flip-chip only	Flip-chip and wire-bond

Notes:
1. AVCCAUXRX for RocketIO X MGT is 1.5V (nominal) for 8B/10B-encoded data. For all other encoding protocols, AVCCAUXRX is 1.8V (nominal).
2. The XC2VPX70 operates at a fixed 4.25 Gb/s baud rate.

Table 2: **Recommended Operating Conditions**

Symbol	Description	Grade	Virtex-II Pro X		Virtex-II Pro		Units
			Min	Max	Min	Max	
V_{CCINT}	Internal supply voltage relative to GND, T_J = 0 °C to +85°C	Comm.	1.425	1.575	1.425	1.575	V
	Internal supply voltage relative to GND, T_J = –40°C to +100°C	Indus.	1.425	1.575	1.425	1.575	V
V_{CCAUX}(1)	Auxiliary supply voltage relative to GND, T_J = 0 °C to +85°C	Comm.	2.375	2.625	2.375	2.625	V
	Auxiliary supply voltage relative to GND, T_J = –40°C to +100°C	Indus.	2.375	2.625	2.375	2.625	V
V_{CCO}(2,3)	Supply voltage relative to GND, T_J = 0 °C to +85°C	Comm.	1.2	3.45(5)	1.2	3.45(5)	V
	Supply voltage relative to GND, T_J = –40°C to +100°C	Indus.	1.2	3.45(5)	1.2	3.45(5)	V
V_{IN}	3.3V supply voltage relative to GND, T_J = 0 °C to +85°C	Comm.	GND – 0.2	3.45(5)	GND – 0.2	3.45(5)	V
	3.3V supply voltage relative to GND, T_J = –40°C to +100°C	Indus.	GND – 0.2	3.45(5)	GND – 0.2	3.45(5)	V
	2.5V and below supply voltage relative to GND, T_J = 0 °C to +85°C	Comm.	GND – 0.2	V_{CCO} + 0.2	GND – 0.2	V_{CCO} + 0.2	V
	2.5V and below supply voltage relative to GND, T_J = –40°C to +100°C	Indus.	GND – 0.2	V_{CCO} + 0.2	GND – 0.2	V_{CCO} + 0.2	V
V_{BATT}(4)	Battery voltage relative to GND, T_J = 0 °C to +85°C	Comm.	1.0	3.6	1.0	3.6	V
	Battery voltage relative to GND, T_J = –40°C to +100°C	Indus.	1.0	3.6	1.0	3.6	V
AVCCAUXRX(6)	Auxilliary receive supply voltage relative to GNDA	Comm.	1.425(7)	1.575(7)	2.375	2.625	V
		Indus.	1.425(7)	1.575(7)	2.375	2.625	V
AVCCAUXTX(6)	Auxilliary transmit supply voltage relative to GNDA	Comm.	2.375	2.625	2.375	2.625	V
		Indus.	2.375	2.625	2.375	2.625	V
V_{TRX}	Terminal receive supply voltage relative to GND	Comm.	0	2.625	1.6	2.625	V
		Indus.	0	2.625	1.6	2.625	V
V_{TTX}	Terminal transmit supply voltage relative to GND	Comm.	1.425	1.575	1.6	2.625	V
		Indus.	1.425	1.575	1.6	2.625	V

Notes:
1. Recommended maximum voltage droop for V_{CCAUX} is 10 mV/ms.
2. Configuration data is retained even if V_{CCO} drops to 0V.
3. For 3.3V I/O operation, refer to **XAPP659**, available on the Xilinx website at **www.xilinx.com**.
4. If battery is not used, connect V_{BATT} to GND or V_{CCAUX}.
5. For PCI and PCI-X, refer to **XAPP653**, available on the Xilinx website at **www.xilinx.com**.
6. **IMPORTANT!** The RocketIO transceivers have certain power guidelines that must be met, even if unused in the design. Please refer to the section entitled “Powering the RocketIO Transceivers” in the ***RocketIO Transceiver User Guide*** or ***RocketIO X Transceiver User Guide*** for more details.
7. For non-8B/10B-encoded data, the specification for AVCCAUXRX is 1.8V ±5% (1.71 – 1.89V).

Virtex-II Pro Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II Pro devices. The numbers reported here are fully characterized worst-case values. Note that these values are subject to the same guidelines as Virtex-II Pro Switching Characteristics (speed files).

Table 13 provides pin-to-pin values (in nanoseconds) including IOB delays; that is, delay through the device from input pin to output pin. In the case of multiple inputs and outputs, the worst delay is reported.

Table 13: **Pin-to-Pin Performance**

Description	Device Used & Speed Grade	Pin-to-Pin Performance (with I/O Delays)	Units
Basic Functions:			
16-bit Address Decoder	XC2VP20FF1152-6	7.20	ns
32-bit Address Decoder	XC2VP20FF1152-6	8.08	ns
64-bit Address Decoder	XC2VP20FF1152-6	8.15	ns
4:1 MUX	XC2VP20FF1152-6	3.85	ns
8:1 MUX	XC2VP20FF1152-6	7.24	ns
16:1 MUX	XC2VP20FF1152-6	7.30	ns
32:1 MUX	XC2VP20FF1152-6	7.64	ns
Combinatorial (pad to LUT to pad)	XC2VP20FF1152-6	3.26	ns
Memory:			
Block RAM			
Pad to setup	XC2VP20FF1152-6	1.72	ns
Clock to Pad	XC2VP20FF1152-6	6.63	ns
Distributed RAM			
Pad to setup	XC2VP20FF1152-6	1.78	ns
Clock to Pad	XC2VP20FF1152-6	4.12	ns

Table 25: **RocketIO Receiver Switching Characteristics**

Description	Symbol	Conditions	Min	Typ	Max	Units
Receive total jitter tolerance	T_{JTOL}	2.126 Gb/s – 3.125 Gb/s			0.65	UI(1)
		1.0626 Gb/s – 2.125 Gb/s			0.65	UI
		1.0 Gb/s – 1.0625 Gb/s			0.68	UI
		600 Mb/s – 999 Mb/s			0.68(2)	UI
Receive deterministic jitter tolerance	T_{DJTOL}	2.126 Gb/s – 3.125 Gb/s			0.41	UI
		1.0626 Gb/s – 2.125 Gb/s			0.43	UI
		1.0 Gb/s – 1.0625 Gb/s			0.47	UI
		600 Mb/s – 999 Mb/s			0.47(2)	
Receive latency(3)	T_{RXLAT}			25	42(4)	RXUSRCLK cycles
RXUSRCLK duty cycle	T_{RXDC}		45	50	55	%
RXUSRCLK2 duty cycle	T_{RX2DC}		45	50	55	%

Notes:

1. UI = Unit Interval
2. The oversampling techniques described in **XAPP572** are required to meet these specifications for serial rates less than 1 Gb/s.
3. Receive latency delay RXP/RXN to RXDATA. Refer to ***RocketIO Transceiver User Guide*** for more information on calculating latency.
4. This maximum may occur when certain conditions are present and clock correction and channel bonding are enabled. If these functions are both disabled, the maximum will be near the typical values.

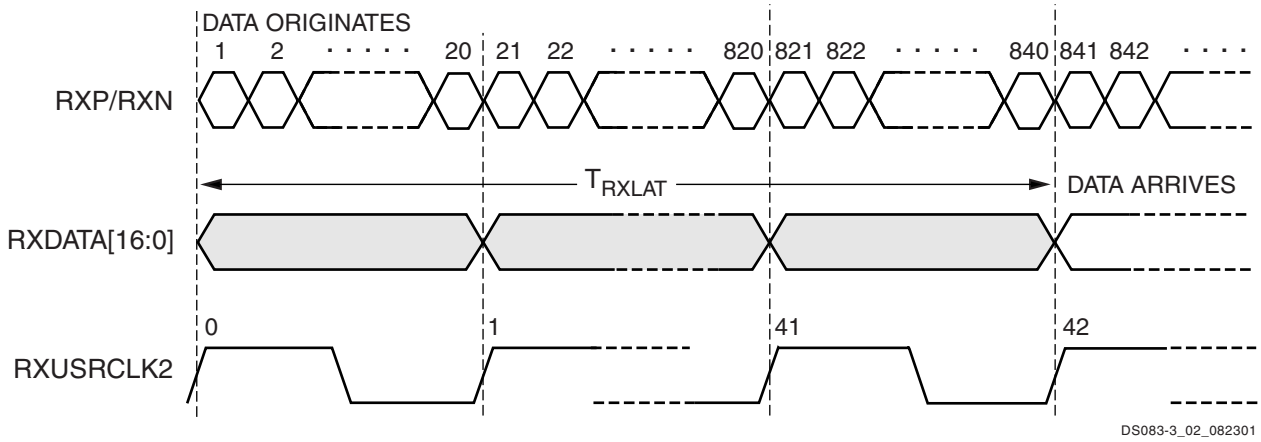

Figure 4: **RocketIO Receive Latency (Maximum)**

Table 32: **RocketIO RXUSRCLK2 Switching Characteristics *(Continued)***

		Speed Grade			
Description	**Symbol**	**-7**	**-6**	**-5**	**Units**
RXBUFSTATUS status outputs	$T_{GCKST_}$RBSTA	0.45	0.45	0.50	ns, max
RXCHECKINGCRC status output	$T_{GCKST_}$RCCRC	0.36	0.40	0.44	ns, max
RXCRCERR status output	$T_{GCKST_}$RCRCE	0.36	0.40	0.44	ns, max
CHBONDDONE status output	$T_{GCKST_}$CHBD	0.50	0.50	0.55	ns, max
RXCHARISK status outputs	$T_{GCKST_}$RKCH	0.50	0.50	0.55	ns, max
RXRUNDISP status outputs	$T_{GCKST_}$RRDIS	0.50	0.50	0.55	ns, max
RXDATA data outputs	$T_{GCKDO_}$RDAT	0.50	0.50	0.55	ns, max
Clock					
RXUSRCLK2 minimum pulse width, High	$T_{GPWH_}$RX2	1.42	1.42	2.25	ns, min
RXUSRCLK2 minimum pulse width, Low	$T_{GPWL_}$RX2	1.42	1.42	2.25	ns, min

Table 33: **RocketIO X TXUSRCLK2 Switching Characteristics**

		Speed Grade			
Description	**Symbol**	**-7**	**-6**	**-5**	**Units**
Setup and Hold Relative to Clock (TXUSRCLK2)					
TXBYPASS8B10B control inputs	$T_{GCCK_}$TBYP/$T_{GCKC_}$TBYP				ns, min
TXPOLARITY control input	$T_{GCCK_}$TPOL/$T_{GCKC_}$TPOL				ns, min
TXINHIBIT control inputs	$T_{GCCK_}$TINH/$T_{GCKC_}$TINH				ns, min
LOOPBACK control inputs	$T_{GCCK_}$LBK/$T_{GCKC_}$LBK				ns, min
TXRESET control input	$T_{GCCK_}$TRST/$T_{GCKC_}$TRST				ns, min
TXCHARISK control inputs	$T_{GCCK_}$TKCH/$T_{GCKC_}$TKCH				ns, min
TXCHARDISPMODE control inputs	$T_{GCCK_}$TCDM/$T_{GCKC_}$TCDM				ns, min
TXCHARDISPVAL control inputs	$T_{GCCK_}$TCDV/$T_{GCKC_}$TCDV				ns, min
TXDATAWIDTH control inputs	$T_{GCCK_}$TDATW/$T_{GCCK_}$TDATW				ns, min
TXENC64B66BUSE TXENC8B10BUSE control inputs	$T_{GCCK_}$TENC/$T_{GCCK_}$TENC				ns, min
TXINTDATAWIDTH control inputs	$T_{GCCK_}$TIDATW/$T_{GCCK_}$TIDATW				ns, min
TXGEARBOX64B66BUSE control inputs	$T_{GCCK_}$TXGEAR/$T_{GCCK_}$TXGEAR				ns, min
TXSCRAM64B66BUSE control inputs	$T_{GCCK_}$TXSCBL/$T_{GCCK_}$TXSCBL				ns, min
REFCLKSEL REFCLKBSEL control inputs	$T_{GCCK_}$RFCKSL/$T_{GCCK_}$RFCKSL				ns, min
TXDATA data inputs	$T_{GDCK_}$TDAT/$T_{GCKD_}$TDAT				ns, min
Clock to Out					
TXBUFERR status output	$T_{GCKST_}$TBERR				ns, max
TXKERR status outputs	$T_{GCKST_}$TKERR				ns, max
TXRUNDISP status outputs	$T_{GCKST_}$TRDIS				ns, max
Clock					
TXUSRCLK2 minimum pulse width, High	$T_{GPWH_}$TX2				ns, min
TXUSRCLK2 minimum pulse width, Low	$T_{GPWL_}$TX2				ns, min

Block SelectRAM+ Switching Characteristics

Table 47: **Block SelectRAM+ Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Sequential Delays					
Clock CLK to DOUT output	T_{BCKO}	1.41	1.50	1.68	ns, max
Setup and Hold Times Before Clock CLK					
ADDR inputs	T_{BACK}/T_{BCKA}	0.27/ 0.22	0.31/ 0.25	0.35/ 0.28	ns, min
DIN inputs	T_{BDCK}/T_{BCKD}	0.20/ 0.22	0.23/ 0.25	0.26/ 0.28	ns, min
EN input	T_{BECK}/T_{BCKE}	0.28/ 0.00	0.32/ 0.00	0.35/ 0.00	ns, min
RST input	T_{BRCK}/T_{BCKR}	0.28/ 0.00	0.32/ 0.00	0.35/ 0.00	ns, min
WEN input	T_{BWCK}/T_{BCKW}	0.33/ 0.00	0.35/ 0.00	0.39/ 0.00	ns, min
Clock CLK					
CLKA to CLKB setup time for different ports	T_{BCCS}	1.0	1.0	1.0	ns, min
Minimum Pulse Width, High	T_{BPWH}	1.17	1.30	1.50	ns, min
Minimum Pulse Width, Low	T_{BPWL}	1.17	1.30	1.50	ns, min

Notes:
1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

TBUF Switching Characteristics

Table 48: **TBUF Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Combinatorial Delays					
IN input to OUT output	T_{IO}	0.88	1.01	1.12	ns, max
TRI input to OUT output high-impedance	T_{OFF}	0.48	0.55	0.61	ns, max
TRI input to valid data on OUT output	T_{ON}	0.48	0.55	0.61	ns, max

FG456/FGG456 Fine-Pitch BGA Package

As shown in Table 6, XC2VP2, XC2VP4, and XC2VP7 Virtex-II Pro devices are available in the FG456/FGG456 fine-pitch BGA package. The pins in these devices are same, except for the differences shown in the "No Connects" column. Following this table are the FG456/FGG456 Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
0	IO_L01N_0/VRP_0	D5			
0	IO_L01P_0/VRN_0	D6			
0	IO_L02N_0	E6			
0	IO_L02P_0	E7			
0	IO_L03N_0	D7			
0	IO_L03P_0/VREF_0	C7			
0	IO_L05_0/No_Pair	E8			
0	IO_L06N_0	D8			
0	IO_L06P_0	C8			
0	IO_L07N_0	F9			
0	IO_L07P_0	E9			
0	IO_L09N_0	D9			
0	IO_L09P_0/VREF_0	D10			
0	IO_L67N_0	F10			
0	IO_L67P_0	E10			
0	IO_L69N_0	C10			
0	IO_L69P_0/VREF_0	B11			
0	IO_L74N_0/GCLK7P	F11			
0	IO_L74P_0/GCLK6S	E11			
0	IO_L75N_0/GCLK5P	D11			
0	IO_L75P_0/GCLK4S	C11			
1	IO_L75N_1/GCLK3P	C12			
1	IO_L75P_1/GCLK2S	D12			
1	IO_L74N_1/GCLK1P	E12			
1	IO_L74P_1/GCLK0S	F12			
1	IO_L69N_1/VREF_1	B12			
1	IO_L69P_1	C13			
1	IO_L67N_1	E13			
1	IO_L67P_1	F13			
1	IO_L09N_1/VREF_1	D13			
1	IO_L09P_1	D14			
1	IO_L07N_1	E14			

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
1	IO_L45N_1/VREF_1	C18			
1	IO_L45P_1	D18			
1	IO_L43N_1	E18			
1	IO_L43P_1	F18			
1	IO_L39N_1	G18			
1	IO_L39P_1	H18			
1	IO_L37N_1	A19			
1	IO_L37P_1	B19			
1	IO_L09N_1/VREF_1	E19			
1	IO_L09P_1	F19			
1	IO_L07N_1	G19			
1	IO_L07P_1	H19			
1	IO_L06N_1	C20			
1	IO_L06P_1	D20			
1	IO_L05_1/No_Pair	E20			
1	IO_L03N_1/VREF_1	F20			
1	IO_L03P_1	G20			
1	IO_L02N_1	D21			
1	IO_L02P_1	E21			
1	IO_L01N_1/VRP_1	D22			
1	IO_L01P_1/VRN_1	E22			
2	IO_L01N_2/VRP_2	C25			
2	IO_L01P_2/VRN_2	C26			
2	IO_L02N_2	D25			
2	IO_L02P_2	D26			
2	IO_L03N_2	E23			
2	IO_L03P_2	F22			
2	IO_L04N_2/VREF_2	E25			
2	IO_L04P_2	E26			
2	IO_L06N_2	F21			
2	IO_L06P_2	G21			
2	IO_L24N_2	F23	NC		
2	IO_L24P_2	F24	NC		
2	IO_L31N_2	F25			

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
6	IO_L55P_6	T2			
6	IO_L55N_6	T1			
6	IO_L57P_6	R9			
6	IO_L57N_6/VREF_6	R8			
6	IO_L59P_6	R6			
6	IO_L59N_6	P6			
6	IO_L60P_6	R5			
6	IO_L60N_6	R4			
6	IO_L85P_6	R2			
6	IO_L85N_6	R1			
6	IO_L87P_6	P9			
6	IO_L87N_6/VREF_6	P8			
6	IO_L89P_6	P5			
6	IO_L89N_6	P4			
6	IO_L90P_6	P3			
6	IO_L90N_6	P2			
7	IO_L90P_7	N2			
7	IO_L90N_7	N3			
7	IO_L88P_7	N4			
7	IO_L88N_7/VREF_7	N5			
7	IO_L86P_7	N8			
7	IO_L86N_7	N9			
7	IO_L85P_7	M1			
7	IO_L85N_7	M2			
7	IO_L60P_7	M4			
7	IO_L60N_7	M5			
7	IO_L58P_7	N6			
7	IO_L58N_7/VREF_7	M6			
7	IO_L56P_7	M8			
7	IO_L56N_7	M9			
7	IO_L55P_7	L1			
7	IO_L55N_7	L2			
7	IO_L54P_7	L5			
7	IO_L54N_7	L6			

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	AVCCAUXRX21	AE7			
N/A	VTRXPAD21	AE6			
N/A	RXNPAD21	AF7			
N/A	RXPPAD21	AF6			
N/A	GNDA21	AD6			
N/A	TXPPAD21	AF5			
N/A	TXNPAD21	AF4			
N/A	VTTXPAD21	AE4			
N/A	AVCCAUXTX21	AE5			
N/A	M2	AD4			
N/A	M0	AF3			
N/A	M1	AE3			
N/A	TDI	D3			
N/A	VCCINT	G10			
N/A	VCCINT	G13			
N/A	VCCINT	G14			
N/A	VCCINT	G17			
N/A	VCCINT	J9			
N/A	VCCINT	J18			
N/A	VCCINT	K7			
N/A	VCCINT	K10			
N/A	VCCINT	K11			
N/A	VCCINT	K16			
N/A	VCCINT	K17			
N/A	VCCINT	K20			
N/A	VCCINT	L10			
N/A	VCCINT	L17			
N/A	VCCINT	N7			
N/A	VCCINT	N20			
N/A	VCCINT	P7			
N/A	VCCINT	P20			
N/A	VCCINT	T10			
N/A	VCCINT	T17			
N/A	VCCINT	U7			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
0	IO_L43P_0	E22				
0	IO_L44N_0	E25				
0	IO_L44P_0	D25				
0	IO_L45N_0	H21				
0	IO_L45P_0/VREF_0	G21				
0	IO_L46N_0	D22				
0	IO_L46P_0	D23				
0	IO_L47N_0	D24				
0	IO_L47P_0	C24				
0	IO_L48N_0	K20				
0	IO_L48P_0	J20				
0	IO_L49N_0	F21				
0	IO_L49P_0	E21				
0	IO_L50_0/No_Pair	C21				
0	IO_L53_0/No_Pair	C22				
0	IO_L54N_0	L19				
0	IO_L54P_0	K19				
0	IO_L55N_0	G20				
0	IO_L55P_0	F20				
0	IO_L56N_0	D21				
0	IO_L56P_0	D20				
0	IO_L57N_0	J19				
0	IO_L57P_0/VREF_0	H19				
0	IO_L67N_0	G19				
0	IO_L67P_0	F19				
0	IO_L68N_0	E19				
0	IO_L68P_0	D19				
0	IO_L69N_0	L18				
0	IO_L69P_0/VREF_0	K18				
0	IO_L73N_0	G18				
0	IO_L73P_0	F18				
0	IO_L74N_0/GCLK7P	E18				
0	IO_L74P_0/GCLK6S	D18				
0	IO_L75N_0/GCLK5P	J18				
0	IO_L75P_0/GCLK4S	H18				
1	IO_L75N_1/GCLK3P	H17				
1	IO_L75P_1/GCLK2S	J17				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
1	IO_L37N_1	G13				
1	IO_L37P_1	H13				
1	IO_L27N_1/VREF_1	J13	NC	NC		
1	IO_L27P_1	K13	NC	NC		
1	IO_L26N_1	D8	NC	NC		
1	IO_L26P_1	E8	NC	NC		
1	IO_L25N_1	F12	NC	NC		
1	IO_L25P_1	G12	NC	NC		
1	IO_L21N_1	G11	NC	NC		
1	IO_L21P_1	H11	NC	NC		
1	IO_L20N_1	C7	NC	NC		
1	IO_L20P_1	D7	NC	NC		
1	IO_L19N_1	E11	NC	NC		
1	IO_L19P_1	F11	NC	NC		
1	IO_L09N_1/VREF_1	J12				
1	IO_L09P_1	K12				
1	IO_L08N_1	D6				
1	IO_L08P_1	D5				
1	IO_L07N_1	E9				
1	IO_L07P_1	F9				
1	IO_L06N_1	J11				
1	IO_L06P_1	K11				
1	IO_L05_1/No_Pair	J10				
1	IO_L03N_1/VREF_1	G10				
1	IO_L03P_1	H10				
1	IO_L02N_1	G9				
1	IO_L02P_1	H9				
1	IO_L01N_1/VRP_1	E7				
1	IO_L01P_1/VRN_1	E6				
2	IO_L01N_2/VRP_2	D2				
2	IO_L01P_2/VRN_2	D1				
2	IO_L02N_2	F8				
2	IO_L02P_2	F7				
2	IO_L03N_2	E4				
2	IO_L03P_2	E3				
2	IO_L04N_2/VREF_2	E2				
2	IO_L04P_2	E1				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
6	IO_L01P_6/VRN_6	AJ30				
6	IO_L01N_6/VRP_6	AJ31				
6	IO_L02P_6	AJ27				
6	IO_L02N_6	AJ28				
6	IO_L03P_6	AK31				
6	IO_L03N_6/VREF_6	AK32				
6	IO_L04P_6	AH29				
6	IO_L04N_6	AH30				
6	IO_L05P_6	AH27				
6	IO_L05N_6	AG28				
6	IO_L06P_6	AL33				
6	IO_L06N_6	AL34				
6	IO_L15P_6	AG29	NC			
6	IO_L15N_6/VREF_6	AG30	NC			
6	IO_L16P_6	AK33	NC			
6	IO_L16N_6	AK34	NC			
6	IO_L17P_6	AF27	NC			
6	IO_L17N_6	AF28	NC			
6	IO_L18P_6	AJ33	NC			
6	IO_L18N_6	AJ34	NC			
6	IO_L19P_6	AH31	NC			
6	IO_L19N_6	AH32	NC			
6	IO_L20P_6	AD25	NC			
6	IO_L20N_6	AD26	NC			
6	IO_L21P_6	AG31	NC			
6	IO_L21N_6/VREF_6	AG32	NC			
6	IO_L22P_6	AF29	NC			
6	IO_L22N_6	AF30	NC			
6	IO_L23P_6	AE27	NC			
6	IO_L23N_6	AE28	NC			
6	IO_L24P_6	AH33	NC			
6	IO_L24N_6	AH34	NC			
6	IO_L31P_6	AF31				
6	IO_L31N_6	AF32				
6	IO_L32P_6	AC25				
6	IO_L32N_6	AC26				
6	IO_L33P_6	AG33				
6	IO_L33N_6/VREF_6	AG34				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
N/A	GND	AF34				
N/A	GND	B34				
N/A	GND	C1				
N/A	GND	C2				
N/A	GND	C10				
N/A	GND	C16				
N/A	GND	C19				
N/A	GND	C25				
N/A	GND	C33				
N/A	GND	C34				
N/A	GND	D4				
N/A	GND	D31				
N/A	GND	E5				
N/A	GND	E12				
N/A	GND	E23				
N/A	GND	E30				
N/A	GND	F6				
N/A	GND	F29				
N/A	GND	G7				
N/A	GND	G28				
N/A	GND	B1				
N/A	GND	H8				
N/A	GND	H12				
N/A	GND	H15				
N/A	GND	H20				
N/A	GND	J1				
N/A	GND	H27				
N/A	GND	AF1				
N/A	GND	K3				
N/A	GND	K32				
N/A	GND	M5				
N/A	GND	M8				
N/A	GND	M27				
N/A	GND	M30				
N/A	GND	P14				
N/A	GND	P15				
N/A	GND	P16				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
4	IO_L47N_4	AE15		
4	IO_L47P_4	AD15		
4	IO_L48N_4	AM14		
4	IO_L48P_4	AL14		
4	IO_L49N_4	AP14		
4	IO_L49P_4	AN14		
4	IO_L50_4/No_Pair	AH15		
4	IO_L53_4/No_Pair	AG16		
4	IO_L54N_4	AK15		
4	IO_L54P_4	AJ15		
4	IO_L55N_4	AM15		
4	IO_L55P_4	AL16		
4	IO_L56N_4	AE16		
4	IO_L56P_4	AD16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AN15		
4	IO_L66N_4	AJ16	NC	
4	IO_L66P_4/VREF_4	AH16	NC	
4	IO_L67N_4	AN16		
4	IO_L67P_4	AM16		
4	IO_L68N_4	AG17		
4	IO_L68P_4	AF17		
4	IO_L69N_4	AJ17		
4	IO_L69P_4/VREF_4	AH17		
4	IO_L73N_4	AL17		
4	IO_L73P_4	AK17		
4	IO_L74N_4/GCLK3S	AE17		
4	IO_L74P_4/GCLK2P	AD17		
4	IO_L75N_4/GCLK1S	AN17		
4	IO_L75P_4/GCLK0P	AM17		
5	IO_L75N_5/GCLK7S	AM18		
5	IO_L75P_5/GCLK6P	AN18		
5	IO_L74N_5/GCLK5S	AD18		
5	IO_L74P_5/GCLK4P	AE18		
5	IO_L73N_5	AK18		
5	IO_L73P_5	AL18		
5	IO_L69N_5/VREF_5	AH18		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	VCCINT	R17		
N/A	VCCINT	AE16		
N/A	VCCINT	AD16		
N/A	VCCINT	T16		
N/A	VCCINT	R16		
N/A	VCCINT	AE15		
N/A	VCCINT	AD15		
N/A	VCCINT	AC15		
N/A	VCCINT	AB15		
N/A	VCCINT	AA15		
N/A	VCCINT	Y15		
N/A	VCCINT	W15		
N/A	VCCINT	V15		
N/A	VCCINT	U15		
N/A	VCCINT	T15		
N/A	VCCINT	R15		
N/A	VCCINT	AF14		
N/A	VCCINT	P14		
N/A	VCCINT	AG13		
N/A	VCCINT	N13		
N/A	VCCINT	AH12		
N/A	VCCINT	M12		
N/A	VCCAUX	AV39		
N/A	VCCAUX	AA39		
N/A	VCCAUX	Y39		
N/A	VCCAUX	W39		
N/A	VCCAUX	B39		
N/A	VCCAUX	AW38		
N/A	VCCAUX	Y38		
N/A	VCCAUX	A38		
N/A	VCCAUX	AR35		
N/A	VCCAUX	E35		
N/A	VCCAUX	AP34		
N/A	VCCAUX	F34		
N/A	VCCAUX	AW20		
N/A	VCCAUX	AV20		
N/A	VCCAUX	B20		
N/A	VCCAUX	A20		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
1	IO_L75N_1/GCLK3P		G21		
1	IO_L75P_1/GCLK2S		F21		
1	IO_L74N_1/GCLK1P		J21		
1	IO_L74P_1/GCLK0S		K21		
1	IO_L73N_1		D20		
1	IO_L73P_1		C20		
1	IO_L69N_1/VREF_1		F20		
1	IO_L69P_1		E20		
1	IO_L68N_1		H20		
1	IO_L68P_1		J20		
1	IO_L67N_1		L20		
1	IO_L67P_1		K20		
1	IO_L66N_1/VREF_1		M20		
1	IO_L66P_1		M21		
1	IO_L65N_1		C19		
1	IO_L65P_1		D19		
1	IO_L64N_1		F19		
1	IO_L64P_1		E19		
1	IO_L60N_1		H19		
1	IO_L60P_1		G19		
1	IO_L59N_1		K19		
1	IO_L59P_1		J19		
1	IO_L58N_1		M19		
1	IO_L58P_1		L19		
1	IO_L57N_1/VREF_1		C17		
1	IO_L57P_1		C18		
1	IO_L56N_1		E18		
1	IO_L56P_1		E17		
1	IO_L55N_1		H18		
1	IO_L55P_1		G18		
1	IO_L54N_1		L18		
1	IO_L54P_1		K18		
1	IO_L53_1/No_Pair		D17		
1	IO_L50_1/No_Pair		D16		
1	IO_L49N_1		G17		
1	IO_L49P_1		F17		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	TXPPAD3		A36		
N/A	GNDA3		C35		
N/A	RXPPAD3		A35		
N/A	RXNPAD3		A34		
N/A	VTRXPAD3		B35		
N/A	AVCCAUXRX3		B34		
N/A	AVCCAUXTX4		B32		
N/A	VTTXPAD4		B33		
N/A	TXNPAD4		A33		
N/A	TXPPAD4		A32		
N/A	GNDA4		C31		
N/A	RXPPAD4		A31		
N/A	RXNPAD4		A30		
N/A	VTRXPAD4		B31		
N/A	AVCCAUXRX4		B30		
N/A	AVCCAUXTX5		B28		
N/A	VTTXPAD5		B29		
N/A	TXNPAD5		A29		
N/A	TXPPAD5		A28		
N/A	GNDA5		C27		
N/A	RXPPAD5		A27		
N/A	RXNPAD5		A26		
N/A	VTRXPAD5		B27		
N/A	AVCCAUXRX5		B26		
N/A	AVCCAUXTX6		B24		
N/A	VTTXPAD6		B25		
N/A	TXNPAD6		A25		
N/A	TXPPAD6		A24		
N/A	GNDA6		C22		
N/A	RXPPAD6		A23		
N/A	RXNPAD6		A22		
N/A	VTRXPAD6		B23		
N/A	AVCCAUXRX6		B22		
N/A	AVCCAUXTX7		B20		
N/A	VTTXPAD7		B21		
N/A	TXNPAD7		A21		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
2	IO_L59N_2	AA11	
2	IO_L59P_2	AA12	
2	IO_L60N_2	W1	
2	IO_L60P_2	W2	
2	IO_L85N_2	Y2	
2	IO_L85P_2	Y3	
2	IO_L86N_2	AA9	
2	IO_L86P_2	AA10	
2	IO_L87N_2	AA5	
2	IO_L87P_2	AA6	
2	IO_L88N_2/VREF_2	AA4	
2	IO_L88P_2	Y4	
2	IO_L89N_2	AA7	
2	IO_L89P_2	AA8	
2	IO_L90N_2	AA2	
2	IO_L90P_2	AA3	
3	IO_L90N_3	AB5	
3	IO_L90P_3	AB6	
3	IO_L89N_3	AB11	
3	IO_L89P_3	AB12	
3	IO_L88N_3	AB2	
3	IO_L88P_3	AB3	
3	IO_L87N_3/VREF_3	AB4	
3	IO_L87P_3	AC4	
3	IO_L86N_3	AB9	
3	IO_L86P_3	AB10	
3	IO_L85N_3	AC2	
3	IO_L85P_3	AC3	
3	IO_L60N_3	AD5	
3	IO_L60P_3	AD6	
3	IO_L59N_3	AB7	
3	IO_L59P_3	AB8	
3	IO_L58N_3	AD1	
3	IO_L58P_3	AD2	
3	IO_L57N_3/VREF_3	AE4	
3	IO_L57P_3	AE5	